





NPN SILICON PLANAR EPITAXIAL RF TRANSISTORS

BF494 BF495

TO-92
Plastic Package

High Voltage Video Transistors

ABSOLUTE MAXIMUM RATINGS(Ta=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	Value	UNITS
			去切四
Collector Emitter Voltage	V_{CEO}	20	L C COM V
Collector Base Voltage	V_{CBO}	30 august N	V
Emitter Base Voltage	V _{EBO}	5	V
Collector Current (DC)	Ic	30	mA
Collector Current(peak value)	I _{CM}	30	mA
Total Power dissipation up to	P _{tot}	300	mW
Tamb = 25°C			mW/ºC
Operating And Storage Junction	T_{j},T_{stg}	-55 to +150	°C
Temperature Range			
THERMAL RESISTANCE			
Junction to ambient	$R_{th(j-a)}$	420	K/W

ELECTRICAL CHARACTERISTICS (Ta=25°C Unless Otherwise Specified)

DESCRIPTION	100	SYMBOL	TEST CONDITION	Min	Max	UNITS
Collector Cut- off Current	E EEE.	I _{CBO}	$V_{CB}=20V,I_{E}=0$		500	nA
Collector Cut - off Current		I_{CBO}	$V_{CB}=20V,I_{E}=0$			
			Ta =150 °C		4.0	μΑ
EmitterCut off Current		I_{EBO}	$V_{EB}=4V$, $I_{C}=0$		500	nA
Base Emitter Voltage		$V_{BE(ON)}$	$V_{CE}=10V,I_{C}=1mA$	0.65	0.74	V ALCOHALV
DC Current Gain						
	BF494	h _{FE} ∗	$I_C=1$ mA, $V_{CE}=10$ V	67	221	
	BF494A			200	500	
	BF494B			110	215	
	BF 495			35	125	
	BF 495C			65	135	
	BF 495D	N. P.		40	85	



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CEB CEB

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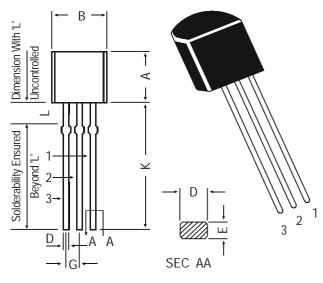
ELECTRICAL CHARACTERISTICS (Ta=25°C Unless Specified Otherwise)

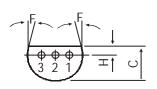
DESCRIPTION	SYMBOL	TEST CONDITION	Min	Max	UNITS
DYNAMIC CHARACTERISTICS					
Transition Frequency	f_T	$I_C=1$ mA, $V_{CE}=10$ V	120		MHz
Feedback Capacitance	C_{re}	V _{CE} =10V, I _C =1mA		1.0	pF
		f=4.5MHz			

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TO-92 Transistors on Tape and Ammo Pack



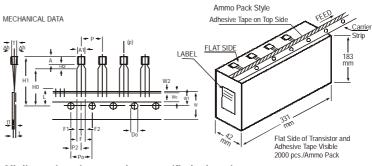


PIN CONFIGURATION

- 1. BASE
- 2. EMITTER
- 3. COLLECTOR

DIM	MIN.	MAX.		
Α	4.32	5.33		
В	4.45	5.20		
С	3.18	4.19		
D	0.41	0.55		
Ε	0.35	0.50		
F	5 DI	EG		
G	1.14	1.40		
Н	1.14	1.53		
K	12.70	_		
L	1.982	2.082		

All diminsions in mm.



All dimensions in mm unless specified otherwise

ITEM			SPECIFICATION			DELLA DIZO	
I I EIVI	SYMBOL	MIN.	NOM.	NOM. MAX. TOL.		REMARKS	
BODY WIDTH BODY HEIGHT BODY THICKNESS PITCH OF COMPONENT	A1 A T P	4.0 4.8 3.9	12.7	4.8 5.2 4.2	. 1		
FEED HOLE PITCH FFED HOLF CENTRE TO	Po		12.7		±1 ±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH	
COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH	
DISTANCE BETWEEN OUTER LEADS COMPONENT ALIGNMENT TAPE WIDTH HOLD-DOWN TAPE WIDTH HOLE POSITION	F △h W Wo W1		5.08 0 18 6 9	1	+0.6 -0.2 ±0.5 ±0.2 +0.7 -0.5	AT TOP OF BODY	
HOLD-DOWN TAPE POSITION LEAD WIRE CLINCH HEIGHT COMPONENT HEIGHT LENGTH OF SNIPPED LEADS FEED HOLE DIAMETER TOTAL TAPE THICKNESS LEAD - TO - LEAD DISTANCEF1,	W2 Ho H1 L Do t		0.5 16 4 2.54	23.25 11.0 1.2	±0.2 ±0.5 ±0.2 +0.4	t1 0.3 - 0.6	
CLINCH HEIGHT PULL - OUT FORCE	H2 (P)	6N		3	-0.1		

- 1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
 2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
- PITCHES.
 HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
 NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
- 5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
 6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

Packing Detail

<u> </u>										
PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX					
	Details Net Weight/Qty		Size	Qty	Size Qty		Gr Wt			
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs			
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs			

Notes BF494 BF495

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Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Discrete Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD is believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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